

# 2PC4081 NPN general-purpose transistor Rev. 06 — 17 November 2009

Product data sheet

#### 1. **Product profile**

## 1.1 General description

NPN transistor in a SOT323 (SC-70) plastic package. The PNP complement is 2PA1576.

## 1.2 Features

- Low current (max. 150 mA)
- Low voltage (max. 50 V)

## **1.3 Applications**

- General-purpose switching
- Small signal amplification

#### 2. **Pinning information**

Table 1.	Pinning		
Pin	Description	Simplified outline	Symbol
1	base		
2	emitter		3
3	collector	1 2	
			sym021

#### 3. **Ordering information**

#### Table 2. **Ordering information**

Type number	Package					
	Name	Description	Version			
2PC4081Q	SC-70	plastic surface mounted package; 3 leads	SOT323			
2PC4081R						
2PC4081S						



## 4. Marking

Table 3. Marking codes		
Type number	Marking code <sup>[1]</sup>	
2PC4081Q	Z*Q	
2PC4081R	Z*R	
2PC4081S	Z*S	

[1] \* = -: made in Hong Kong

\* = t: made in Malaysia

## 5. Limiting values

#### Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
$V_{CBO}$	collector-base voltage	open emitter	-	60	V
$V_{CEO}$	collector-emitter voltage	open base	-	50	V
$V_{\text{EBO}}$	emitter-base voltage	open collector	-	7	V
I <sub>C</sub>	collector current (DC)		-	150	mA
I <sub>CM</sub>	peak collector current		-	200	mA
I <sub>BM</sub>	peak base current		-	200	mA
P <sub>tot</sub>	total power dissipation	$T_{amb} \le 25 \ ^{\circ}C$	<u>[1]</u> _	200	mW
T <sub>stg</sub>	storage temperature		-65	+150	°C
Tj	junction temperature		-	150	°C
T <sub>amb</sub>	ambient temperature		-65	+150	°C

[1] Transistor mounted on an FR4 printed-circuit board, single-sided copper, tin-plated and standard footprint.

## 6. Thermal characteristics

Table 5.	Thermal characteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R <sub>th(j-a)</sub>	thermal resistance from junction to ambient		<u>[1]</u> _	-	625	K/W

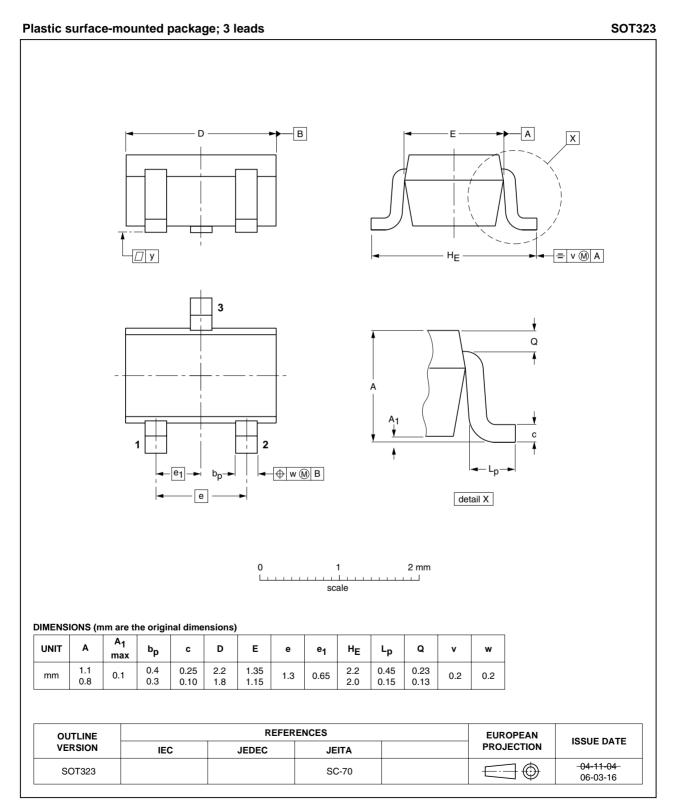
[1] Transistor mounted on an FR4 printed-circuit board, single-sided copper, tin-plated and standard footprint.

# 7. Characteristics

Symbol	Parameter	Conditions	Min	Тур	Мах	Unit
I <sub>CBO</sub>	collector-base	$I_E = 0 \text{ A}; V_{CB} = 30 \text{ V}$	-	-	100	nA
	cut-off current	$I_E = 0 \text{ A}; V_{CB} = 30 \text{ V};$ $T_j = 150 \text{ °C}$	-	-	5	μA
I <sub>EBO</sub>	emitter-base cut-off current	$I_{C} = 0 A; V_{EB} = 4 V$	-	-	100	nA
h <sub>FE</sub>	DC current gain	$I_{C} = 1 \text{ mA}; V_{CE} = 6 \text{ V}$				
	2PC4081Q		120	-	270	
	2PC4081R		180	-	390	
	2PC4081S		270	-	560	
V <sub>CEsat</sub>	collector-emitter saturation voltage	I <sub>C</sub> = 50 mA; I <sub>B</sub> = 5 mA	<u>[1]</u> -	-	400	mV
C <sub>c</sub>	collector capacitance	I <sub>E</sub> = i <sub>e</sub> = 0 A; V <sub>CB</sub> = 12 V; f = 1 MHz	-	2	3.5	pF
f⊤	transition frequency	I <sub>C</sub> = 2 mA; V <sub>CE</sub> = 12 V; f = 100 MHz	100	-	-	MHz

[1] Pulse test:  $t_p \le 300 \ \mu s$ ;  $\delta \le 0.02$ .

## 8. Package outline



#### Fig 1. Package outline SOT323 (SC-70)

# 9. Revision history

Table 7. Revision histo	ory			
Document ID	Release date	Data sheet status	Change notice	Supersedes
2PC4081_6	20091117	Product data sheet	-	2PC4081_5
Modifications:	including new le content.	was changed to reflect the egal definitions and disclair age outline SOT323 (SC-70	ners. No changes we	
2PC4081_5	20041125	Product data sheet	-	2PC4081_4
2PC4081_4	19990408	Product specification	-	2PC4081_3
2PC4081_3	19970704	Product specification	-	2PC4081_2
2PC4081_2	19931213	n.a.	-	n.a.

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## **10.1** Data sheet status

Document status[1][2]	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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### NPN general-purpose transistor

## **12. Contents**

1	Product profile 1
1.1	General description 1
1.2	Features 1
1.3	Applications 1
2	Pinning information 1
3	Ordering information 1
4	Marking 2
5	Limiting values 2
6	Thermal characteristics 2
7	Characteristics 3
8	Package outline 4
9	Revision history 5
10	Legal information 6
10.1	Data sheet status 6
10.2	Definitions
10.3	Disclaimers 6
10.4	Trademarks
11	Contact information 6
12	Contents

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